

FPGA World Conference Copenhagen 2018



FPGA World Conference DTU Lyngby Sept. 20, 2018



Pieter Hazewindus, R&D director, Synopsys



Stefan Bauer, application engineer Mentor Graphics



Stefan Bauer and Yehoshua Shoshan (Innofour, Sweden) presented design tools from Mentor Graphics



John Adair, Enterpoint Ltd., UK



Yasser Bajwa, FPGA designer,
Grazpers, Denmark



Mike Dini. DINI Group, California USA



Mike Dini presented big FPGA boards



Nikolay Rognlien, market development engineer, Arrow Norway



Nikolay Rognlien presented Intel's FPGA boards



Ole Højrup, field application engineer, presented Xilinx' FPGA boards



Xilinx' FPGA development boards



Companies from the Nordic countries, USA and Taiwan presented their products at the conference



Christian Bangert (Germany), Jamie Chen (Winbond) and Søren Manicus, IndesmaTech presented Winbond's memories

